Low Capacitance, Low Charge Injection, ±15 V/+12 V *i*CMOS Quad SPST Switches

Enhanced Product

ADG1212-EP

FEATURES

1 pF off capacitance
2.6 pF on capacitance
<1 pC charge injection
33 V supply range
120 Ω on resistance
Fully specified at ±15 V, +12 V
No V_L supply required
3 V logic-compatible inputs
Rail-to-rail operation
16-lead TSSOP
Typical power consumption: <0.03 µW

ENHANCED PRODUCT FEATURES

Supports defense and aerospace applications (AQEC standard)
Military temperature range: −55°C to +125°C
Controlled manufacturing baseline
1 assembly/test site
1 fabrication site
Product change notification
Qualification data available on request

APPLICATIONS

Automatic test equipment
Data acquisition systems
Battery-powered systems
Sample-and-hold systems
Audio signal routing
Video signal routing
Communication systems

GENERAL DESCRIPTION

The ADG1212-EP is a monolithic complementary metal-oxide semiconductor (CMOS) device containing four independently selectable switches designed on an *i*CMOS® (industrial CMOS) process. *i*CMOS is a modular manufacturing process combining high voltage CMOS and bipolar technologies. It enables the development of a wide range of high performance analog ICs capable of 33 V operation in a footprint that no previous generation of high voltage parts has been able to achieve. Unlike analog ICs using conventional CMOS processes, *i*CMOS components can tolerate high supply voltages while providing increased performance, dramatically lower power consumption, and reduced package size.

FUNCTIONAL BLOCK DIAGRAM

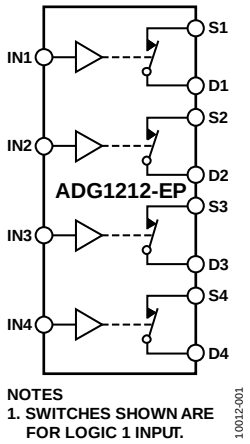

Figure 1.

The ultralow capacitance and charge injection of this switch makes it an ideal solution for data acquisition and sample-and-hold applications, where low glitch and fast settling are required. Fast switching speed coupled with high signal bandwidth makes the part suitable for video signal switching.

*i*CMOS construction ensures ultralow power dissipation, making the part ideally suited for portable and battery-powered instruments.

The ADG1212-EP contains four independent single-pole/single-throw (SPST) switches. Each switch conducts equally well in both directions when on and has an input signal range that extends to the supplies. In the off condition, signal levels up to the supplies are blocked.

Additional application and technical information can be found in the ADG1212 data sheet.

PRODUCT HIGHLIGHTS

1. Ultralow capacitance.
2. <1 pC charge injection.
3. 3 V logic compatible digital inputs: V_{IH} = 2.0 V, V_{IL} = 0.8 V.
4. No V_L logic power supply required.
5. Ultralow power dissipation: <0.03 µW.
6. 16-lead TSSOP package.

Rev. B Document Feedback

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Tel: 781.329.4700
Technical Support **www.analog.com**

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REVISION HISTORY

5/2018—Rev. A to Rev. B

Change to Enhanced Product Features Section 1
Changes to Ordering Guide 11

7/2012—Rev. 0 to Rev. A

Changed Operating Temperature Range from −40°C to +125°C to −55°C to +125°C; Table 3 5

11/2011—Revision 0: Initial Version

SPECIFICATIONS

DUAL SUPPLY

V_{DD} = 15 V ± 10%, V_{SS} = −15 V ± 10%, GND = 0 V, unless otherwise noted.

Table 1.

Parameter	25°C	−40°C to +85°C	−55°C to +125°C	Unit	Test Conditions/Comments
ANALOG SWITCH					
Analog Signal Range			V_{DD} to V_{SS}	V	
On Resistance (R_{ON})	120			Ω typ	V_S = ±10 V, I_S = −1 mA; see Figure 15
	190	230	260	Ω max	V_{DD} = +13.5 V, V_{SS} = −13.5 V
On Resistance Match Between Channels (ΔR_{ON})	2.5			Ω typ	V_S = ±10 V, I_S = −1 mA
	6	10	11	Ω max	
On Resistance Flatness ($R_{FLAT(ON)}$)	20			Ω typ	V_S = −5 V/0 V/+5 V; I_S = −1 mA
	57	72	79	Ω max	
LEAKAGE CURRENTS					V_{DD} = +16.5 V, V_{SS} = −16.5 V
Source Off Leakage, I_S (Off)	±0.02			nA typ	V_S = ±10 V, V_D = ±10 V; see Figure 11
	±0.1	±0.6	±1	nA max	
Drain Off Leakage, I_D (Off)	±0.02			nA typ	V_S = ±10 V, V_D = ±10 V; see Figure 11
	±0.1	±0.6	±1	nA max	
Channel On Leakage, I_D, I_S (On)	±0.02			nA typ	V_S = V_D = ±10 V; see Figure 12
	±0.1	±0.6	±1	nA max	
DIGITAL INPUTS					
Input High Voltage, V_{INH}			2.0	V min	
Input Low Voltage, V_{INL}			0.8	V max	
Input Current, I_{INL} or I_{INH}	0.005			μA typ	V_{IN} = V_{INL} or V_{INH}
			±0.1	μA max	
Digital Input Capacitance, C_{IN}	2.5			pF typ	
DYNAMIC CHARACTERISTICS[1]					
t_{ON}	65			ns typ	R_L = 300 Ω, C_L = 35 pF
	80	95	110	ns max	V_S = 10 V; see Figure 18
t_{OFF}	80			ns typ	R_L = 300 Ω, C_L = 35 pF
	100	115	135	ns max	V_S = 10 V; see Figure 18
Charge Injection	−0.3			pC typ	V_S = 0 V, R_S = 0 Ω, C_L = 1 nF; see Figure 19
Off Isolation	80			dB typ	R_L = 50 Ω, C_L = 5 pF, f = 1 MHz; see Figure 13
Channel-to-Channel Crosstalk	90			dB typ	R_L = 50 Ω, C_L = 5 pF, f = 1 MHz; see Figure 14
Total Harmonic Distortion + Noise	0.15			% typ	R_L = 10 kΩ, 5 V rms, f = 20 Hz to 20 kHz; see Figure 17
−3 dB Bandwidth	1000			MHz typ	R_L = 50 Ω, C_L = 5 pF; see Figure 16
C_S (Off)	0.9			pF typ	V_S = 0 V, f = 1 MHz
	1.1			pF max	V_S = 0 V, f = 1 MHz
C_D (Off)	1			pF typ	V_S = 0 V, f = 1 MHz
	1.2			pF max	V_S = 0 V, f = 1 MHz
C_D, C_S (On)	2.6			pF typ	V_S = 0 V, f = 1 MHz
	3			pF max	V_S = 0 V, f = 1 MHz
POWER REQUIREMENTS					V_{DD} = +16.5 V, V_{SS} = −16.5 V
I_{DD}	0.001			μA typ	Digital inputs = 0 V or V_{DD}
			1.0	μA max	
I_{DD}	220			μA typ	Digital inputs = 5 V
			420	μA max	
I_{SS}	0.001			μA typ	Digital inputs = 0 V or V_{DD}
			1.0	μA max	
I_{SS}	0.001			μA typ	Digital inputs = 5 V
			1.0	μA max	

[1] Guaranteed by design, not subject to production test.

SINGLE SUPPLY

V_{DD} = 12 V ± 10%, V_{SS} = 0 V, GND = 0 V, unless otherwise noted.

Table 2.

Parameter	25°C	−40°C to +85°C	−55°C to +125°C	Unit	Test Conditions/Comments
ANALOG SWITCH					
Analog Signal Range			0 V to V_{DD}	V	
On Resistance (R_{ON})	300			Ω typ	V_S = 0 V to 10 V, I_S = −1 mA; see Figure 15
	475	567	625	Ω max	V_{DD} = 10.8 V, V_{SS} = 0 V
On Resistance Match Between Channels (ΔR_{ON})	4.5			Ω typ	V_S = 0 V to 10 V, I_S = −1 mA
	12	26	27	Ω max	
On Resistance Flatness ($R_{FLAT(ON)}$)	60			Ω typ	V_S = 3 V/6 V/9 V, I_S = −1 mA
LEAKAGE CURRENTS					V_{DD} = 13.2 V, V_{SS} = 0 V
Source Off Leakage, I_S (Off)	±0.02			nA typ	V_S = 1 V/10 V, V_D = 10 V/1 V; see Figure 11
	±0.1	±0.6	±1	nA max	
Drain Off Leakage, I_D (Off)	±0.02			nA typ	V_S = 1 V/10 V, V_D = 10 V/1 V; see Figure 11
	±0.1	±0.6	±1	nA max	
Channel On Leakage, I_D, I_S (On)	±0.02			nA typ	V_S = V_D = 1 V or 10 V; see Figure 12
	±0.1	±0.6	±1	nA max	
DIGITAL INPUTS					
Input High Voltage, V_{INH}			2.0	V min	
Input Low Voltage, V_{INL}			0.8	V max	
Input Current, I_{INL} or I_{INH}	0.001			μA typ	V_{IN} = V_{INL} or V_{INH}
			±0.1	μA max	
Digital Input Capacitance, C_{IN}	3			pF typ	
DYNAMIC CHARACTERISTICS[1]					
t_{ON}	80			ns typ	R_L = 300 Ω, C_L = 35 pF
	105	125	140	ns max	V_S = 8 V; see Figure 18
t_{OFF}	90			ns typ	R_L = 300 Ω, C_L = 35 pF
	115	140	165	ns max	V_S = 8 V; see Figure 18
Charge Injection	0			pC typ	V_S = 6 V, R_S = 0 Ω, C_L = 1 nF; see Figure 19
Off Isolation	80			dB typ	R_L = 50 Ω, C_L = 5 pF, f = 1 MHz; see Figure 13
Channel-to-Channel Crosstalk	90			dB typ	R_L = 50 Ω, C_L = 5 pF, f = 1 MHz; see Figure 14
−3 dB Bandwidth	900			MHz typ	R_L = 50 Ω, C_L = 5 pF; see Figure 16
C_S (Off)	1.2			pF typ	V_S = 6 V, f = 1 MHz
	1.4			pF max	V_S = 6 V, f = 1 MHz
C_D (Off)	1.3			pF typ	V_S = 6 V, f = 1 MHz
	1.5			pF max	V_S = 6 V, f = 1 MHz
C_D, C_S (On)	3.2			pF typ	V_S = 6 V, f = 1 MHz
	3.9			pF max	V_S = 6 V, f = 1 MHz
POWER REQUIREMENTS					V_{DD} = 13.2 V
I_{DD}	0.001			μA typ	Digital inputs = 0 V or V_{DD}
			1.0	μA max	
I_{DD}	220			μA typ	Digital inputs = 5 V
			420	μA max	

[1] Guaranteed by design, not subject to production test.

ABSOLUTE MAXIMUM RATINGS

T_A = 25°C, unless otherwise noted.

Table 3.

Parameter	Rating
V_{DD} to V_{SS}	35 V
V_{DD} to GND	−0.3 V to +25 V
V_{SS} to GND	+0.3 V to −25 V
Analog Inputs[1]	V_{SS} − 0.3 V to V_{DD} + 0.3 V or 30 mA, whichever occurs first
Digital Inputs[1]	GND − 0.3 V to V_{DD} + 0.3 V or 30 mA, whichever occurs first
Peak Current, S or D	100 mA (pulsed at 1 ms, 10% duty cycle maximum)
Continuous Current per Channel, S or D	25 mA
Operating Temperature Range	−55°C to +125°C
Storage Temperature Range	−65°C to +150°C
Junction Temperature	150°C
16-Lead TSSOP, θ_{JA} Thermal Impedance (4-Layer Board)	112°C/W
Lead Temperature, Soldering	As per JEDEC J-STD-020

[1] Overvoltages at IN, S, or D are clamped by internal diodes. Current should be limited to the maximum ratings given.

Stresses at or above those listed under Absolute Maximum Ratings may cause permanent damage to the product. This is a stress rating only; functional operation of the product at these or any other conditions above those indicated in the operational section of this specification is not implied. Operation beyond the maximum operating conditions for extended periods may affect product reliability.

Only one absolute maximum rating may be applied at any one time.

Table 4. ADG1212-EP Truth Table

ADG1212-EP INx	Switch Condition
1	On
0	Off

ESD CAUTION

ESD (electrostatic discharge) sensitive device. Charged devices and circuit boards can discharge without detection. Although this product features patented or proprietary protection circuitry, damage may occur on devices subjected to high energy ESD. Therefore, proper ESD precautions should be taken to avoid performance degradation or loss of functionality.

PIN CONFIGURATION AND FUNCTION DESCRIPTIONS

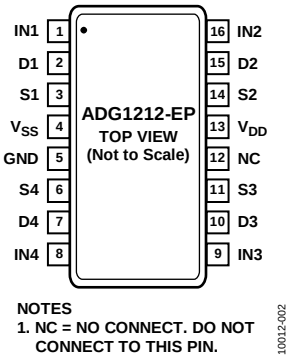

Figure 2. Pin Configuration

Table 5. Pin Function Descriptions

Pin No.	Mnemonic	Description
1	IN1	Logic Control Input.
2	D1	Drain Terminal. This pin can be an input or output.
3	S1	Source Terminal. This pin can be an input or output.
4	V_{SS}	Most Negative Power Supply Potential.
5	GND	Ground (0 V) Reference.
6	S4	Source Terminal. This pin can be an input or output.
7	D4	Drain Terminal. This pin can be an input or output.
8	IN4	Logic Control Input.
9	IN3	Logic Control Input.
10	D3	Drain Terminal. This pin can be an input or output.
11	S3	Source Terminal. This pin can be an input or output.
12	NC	No Connection.
13	V_{DD}	Most Positive Power Supply Potential.
14	S2	Source Terminal. This pin can be an input or output.
15	D2	Drain Terminal. This pin can be an input or output.
16	IN2	Logic Control Input.

TYPICAL PERFORMANCE CHARACTERISTICS

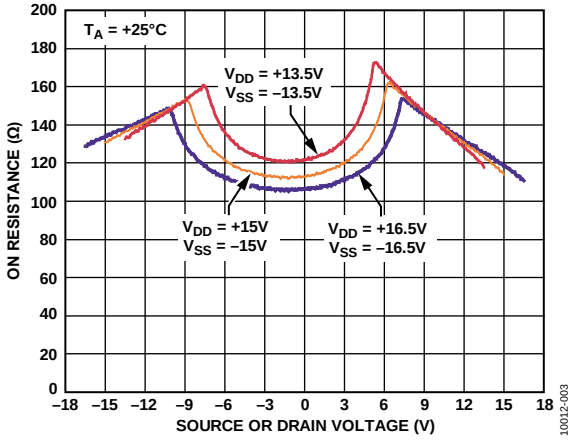

Figure 3. On Resistance as a Function of V_D (V_S) for Dual Supply

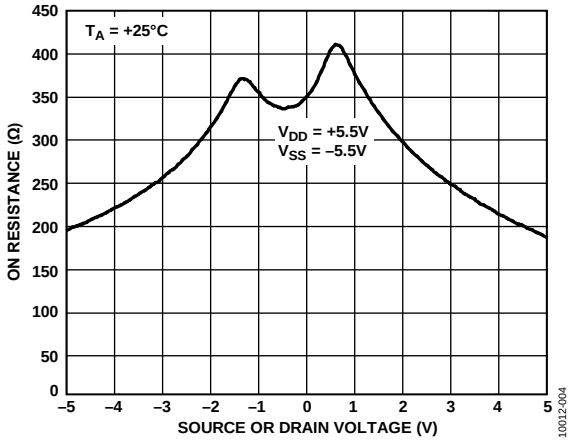

Figure 4. On Resistance as a Function of V_D (V_S) for Dual Supply

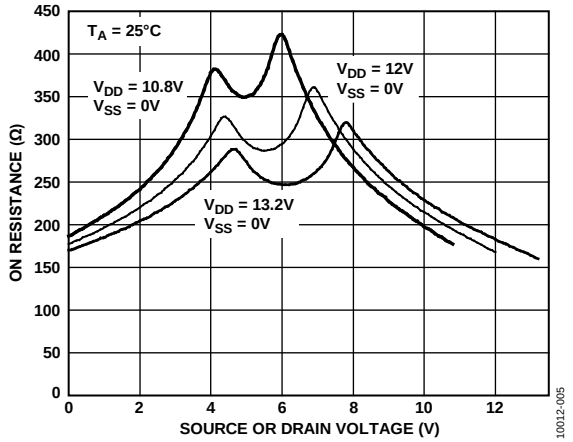

Figure 5. On Resistance as a Function of V_D (V_S) for Single Supply

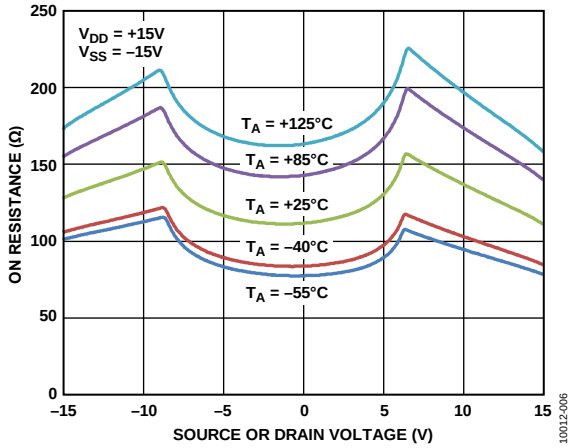

Figure 6. On Resistance as a Function of V_D (V_S) for Different Temperatures, Dual Supply

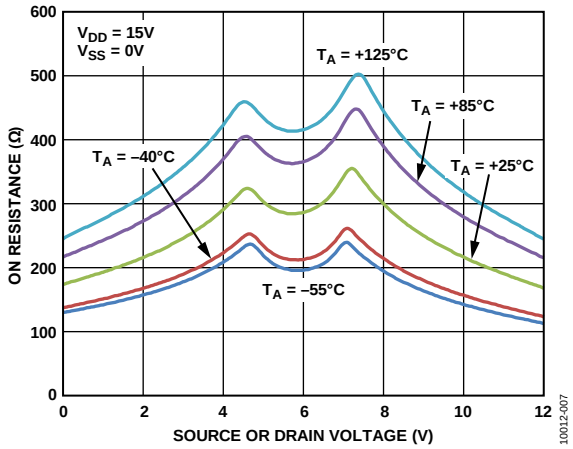

Figure 7. On Resistance as a Function of V_D (V_S) for Different Temperatures, Single Supply

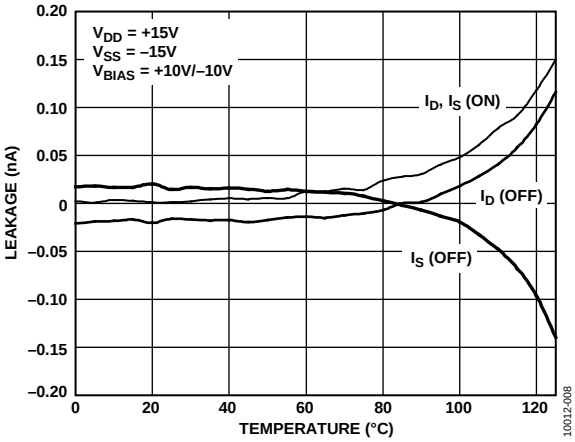

Figure 8. Leakage Currents as a Function of Temperature, Dual Supply

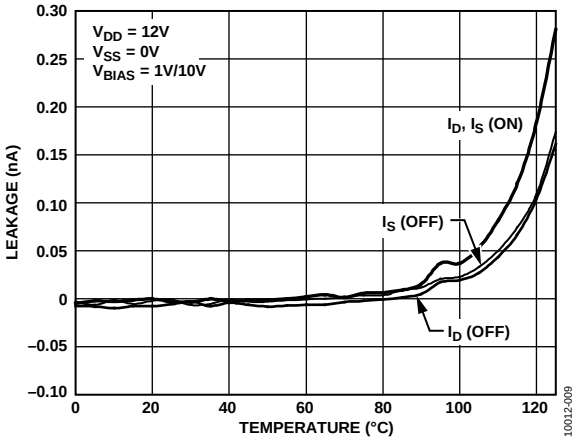

Figure 9. Leakage Currents as a Function of Temperature, Single Supply

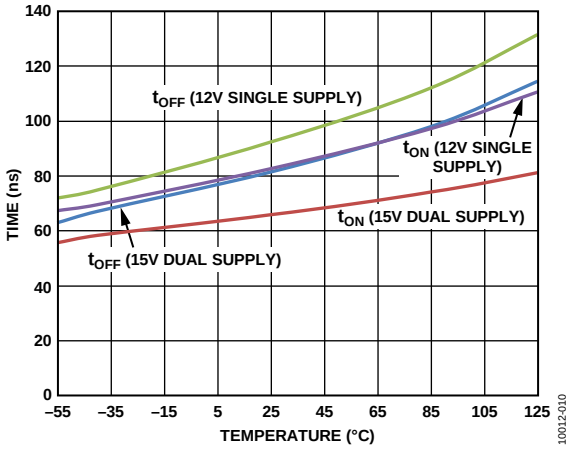

Figure 10. t_{ON}/t_{OFF} Times vs. Temperature

TEST CIRCUITS

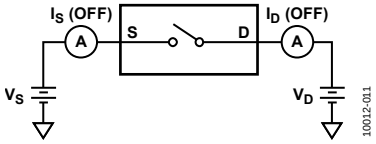

Figure 11. Off Leakage

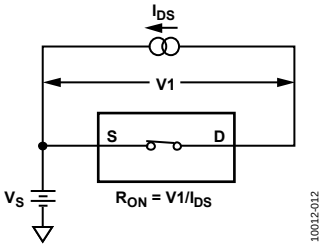

Figure 12. On Leakage

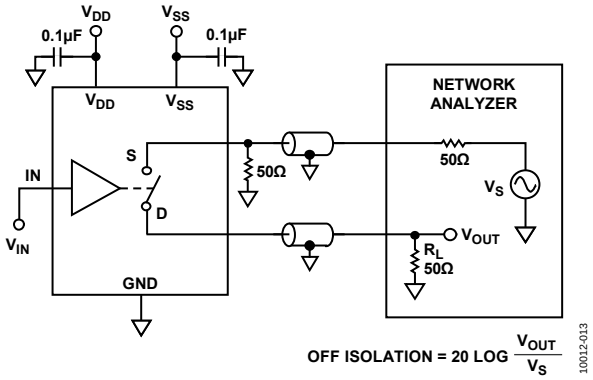

Figure 13. Off Isolation

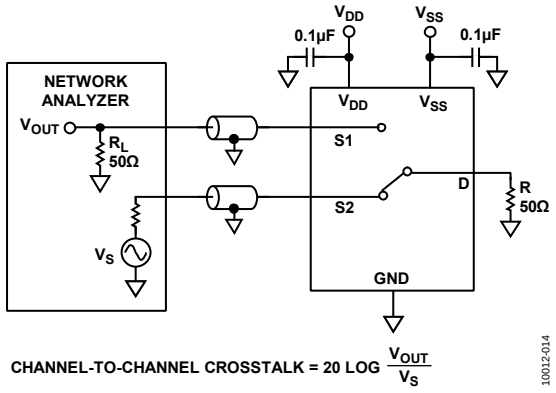

Figure 14. Channel-to-Channel Crosstalk

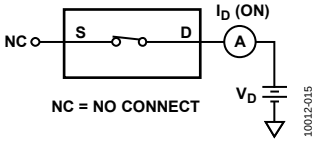

Figure 15. On Resistance

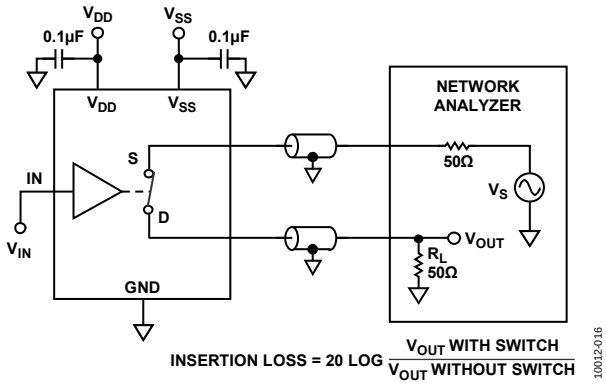

Figure 16. Bandwidth

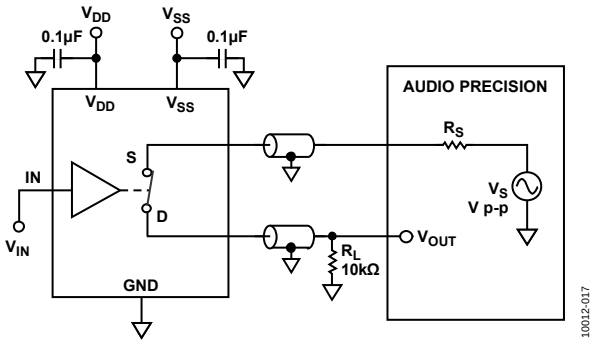

Figure 17. THD + Noise

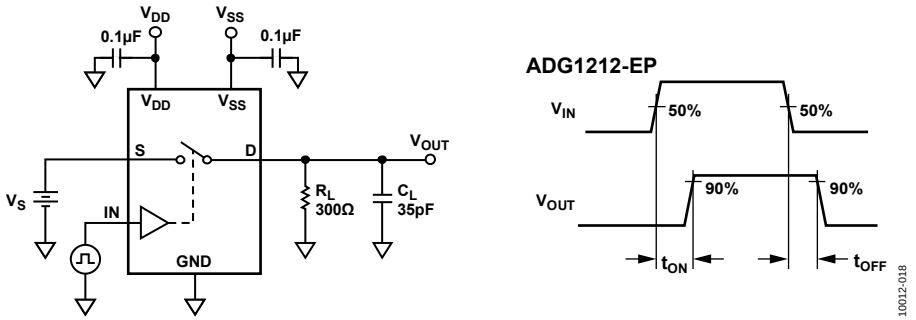

Figure 18. Switching Times

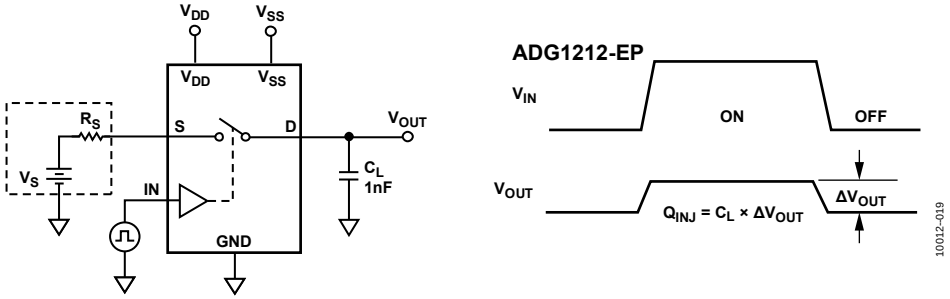

Figure 19. Charge Injection

OUTLINE DIMENSIONS

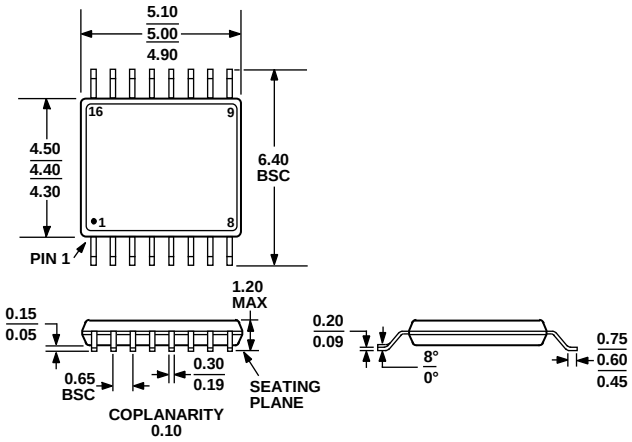

Figure 20. 16-Lead Thin Shrink Small Outline Package [TSSOP]
(RU-16)
Dimensions shown in millimeters

ORDERING GUIDE

Model[1]	Temperature Range	Package Description	Package Option
ADG1212SRU-EP-RL7	−55°C to +125°C	16-Lead Thin Shrink Small Outline Package [TSSOP]	RU-16
ADG1212SRUZ-EP-RL7	−55°C to +125°C	16-Lead Thin Shrink Small Outline Package [TSSOP]	RU-16

[1] Z = RoHS Compliant Part

NOTES

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Other Similar products are found below :

FSA3051TMX NLAS4684FCTCG NLAS5223BLMNR2G NLVAS4599DTT1G NLX2G66DMUTCG 425541DB 425528R 099044FB NLAS5123MNR2G PI5A4157CEX PI5A4599BCEX NLAS4717EPFCT1G PI5A3167CCEX SLAS3158MNR2G PI5A392AQE PI5A4157ZUEX PI5A3166TAEX FSA634UCX TC4066BP(N,F) DG302BDJ-E3 PI5A100QEX HV2605FG-G HV2301FG-G RS2117YUTQK10 RS2118YUTQK10 RS2227XUTQK10 ADG452BRZ-REEL7 MAX4066ESD+ MAX391CPE+ MAX4730EXT+T MAX314CPE+ BU4066BCFV-E2 MAX313CPE+ BU4S66G2-TR NLAS3158MNR2G NLASB3157MTR2G TS3A4751PWR NLAS4157DFT2G NLAS4599DFT2G NLASB3157DFT2G NLAST4599DFT2G NLAST4599DTT1G DG300BDJ-E3 DG2503DB-T2-GE1 DG2502DB-T2-GE1 TC4W53FU(TE12L,F) 74HC2G66DC.125 ADG619BRMZ-REEL ADG1611BRUZ-REEL7 LTC201ACN#PBF